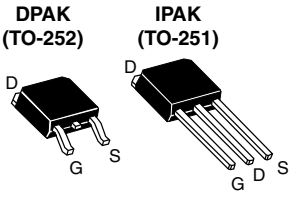
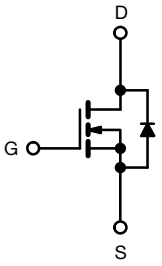
IRFR1N60A, IRFU1N60A, SiHFR1N60A, SiHFU1N60A

Power MOSFET





N-Channel MOSFET

FEATURES

- Low gate charge Q_g results in simple drive requirement
- Improved gate, avalanche and dynamic dV/dt ruggedness
- Fully characterized capacitance and avalanche voltage and current
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT
HALOGEN FREE Available

APPLICATIONS

- Switch mode power supply (SMPS)
- Uninterruptible power supply
- Power factor correction

TYPICAL SMPS TOPOLOGIES

- Low power single transistor flyback

PRODUCT SUMMARY		
V_{DS} (V)	600	
$R_{DS(on)}$ max. (Ω)	V_{GS} = 10 V	7.0
Q_g max. (nC)	14	
Q_{gs} (nC)	2.7	
Q_{gd} (nC)	8.1	
Configuration	Single	

ORDERING INFORMATION				
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)
Lead (Pb)-free and halogen-free	SiHFR1N60A-GE3	SiHFR1N60ATRL-GE3 [a]	SiHFR1N60ATR-GE3 [a]	SiHFU1N60A-GE3
	IRFR1N60APbF-BE3 [ab]	IRFR1N60ATRPbF-BE3 [ab]	SiHFR1N60ATRR-GE3 [a]	-
Lead (Pb)-free	IRFR1N60APbF	IRFR1N60ATRLPbF [a]	IRFR1N60ATRPbF [a]	IRFU1N60APbF

Notes

a. See device orientation
b. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V_{DS}	600	V
Gate-source voltage			V_{GS}	± 30	
Continuous drain current	V_{GS} at 10 V	T_C = 25 °C	I_D	1.4	A
		T_C = 100 °C		0.89	
Pulsed drain current [a]			I_{DM}	5.6	
Linear derating factor				0.28	W/°C
Single pulse avalanche energy [b]			E_{AS}	93	mJ
Repetitive avalanche current [a]			I_{AR}	1.4	A
Repetitive avalanche energy [a]			E_{AR}	3.6	mJ
Maximum power dissipation	T_A = 25 °C		P_D	36	W
Peak diode recovery dV/dt [c]			dV/dt	3.8	V/ns
Operating junction and storage temperature range			T_J, T_{stg}	-55 to +150	°C
Soldering recommendations (peak temperature) [d]	for 10 s			300	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
b. Starting T_J = 25 °C, L = 95 mH, R_g = 25 Ω, I_{AS} = 1.4 A (see fig. 12)
c. $I_{SD} \leq 1.4$ A, dI/dt ≤ 180 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq 150$ °C
d. 1.6 mm from case

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THERMAL RESISTANCE RATINGS				
PARAMETER	**SYMBOL**	**TYP.**	**MAX.**	**UNIT**
Maximum junction-to-ambient	R_{thJA}	-	110	°C/W
Maximum junction-to-ambient (PCB mount) [a]	R_{thJA}	-	50	
Maximum junction-to-case (drain)	R_{thJC}	-	3.5	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material)

SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)							
PARAMETER	**SYMBOL**	**TEST CONDITIONS**		**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static							
Drain-source breakdown voltage	V_{DS}	V_{GS} = 0 V, I_D = 250 µA		600	-	-	V
V_{DS} temperature coefficient	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 250 µA		2.0	-	4.0	
Gate-source threshold voltage	I_{GSS}	V_{GS} = ± 30 V		-	-	± 100	nA
Gate-source leakage	I_{DSS}	V_{DS} = 600 V, V_{GS} = 0 V		-	-	25	µA
Zero gate voltage drain current		V_{DS} = 480 V, V_{GS} = 0 V, T_J = 150 °C		-	-	250	
	$R_{DS(on)}$	V_{GS} = 10 V	I_D = 0.84 A [b]	-	-	7.0	Ω
Drain-source on-state resistance	g_{fs}	V_{DS} = 50 V, I_D = 0.84 A		0.88	-	-	S
Dynamic							
Input capacitance	C_{iss}	V_{GS} = 0 V, V_{DS} = 25 V, f = 1.0 MHz, see fig. 5		-	229	-	pF
Output capacitance	C_{oss}			-	32.6	-	
Reverse transfer capacitance	C_{rss}			-	2.4	-	
Output capacitance	C_{oss}	V_{GS} = 0 V	V_{DS} = 1.0 V, f = 1.0 MHz	-	320	-	
			V_{DS} = 480 V, f = 1.0 MHz	-	11.5	-	
Effective output capacitance	C_{oss} eff.		V_{DS} = 0 V to 480 V [c]	-	130	-	
Total gate charge	Q_g	V_{GS} = 10 V	I_D = 1.4 A, V_{DS} = 400 V, see fig. 6 and 13 [b]	-	-	14	nC
Gate-source charge	Q_{gs}			-	-	2.7	
Gate-drain charge	Q_{gd}			-	-	8.1	
Turn-on delay time	$t_{d(on)}$	V_{DD} = 250 V, I_D = 1.4 A, R_g = 2.15 Ω, R_D = 178 Ω, see fig. 10 [b]		-	9.8	-	ns
Rise time	t_r			-	14	-	
Turn-off delay time	$t_{d(off)}$			-	18	-	
Fall time	t_f			-	20	-	
Drain-source body diode characteristics							
Continuous source-drain diode current	I_S	MOSFET symbol showing the integral reverse p - n junction diode 		-	-	1.4	A
Pulsed diode forward current [a]	I_{SM}			-	-	5.6	
Body diode voltage	V_{SD}	T_J = 25 °C, I_S = 1.4 A, V_{GS} = 0 V [b]		-	-	1.6	V
Body diode reverse recovery time	t_{rr}	T_J = 25 °C, I_F = 1.4 A, dI/dt = 100 A/µs [b]		-	290	440	ns
Body diode reverse recovery charge	Q_{rr}			-	510	760	µC
Forward turn-on time	t_{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)					

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width ≤ 300 µs; duty cycle ≤ 2 %

c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80 % V_{DS}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

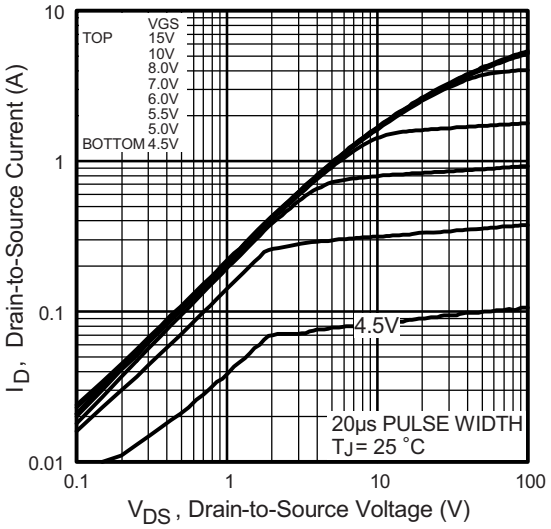


Fig. 1 - Typical Output Characteristics

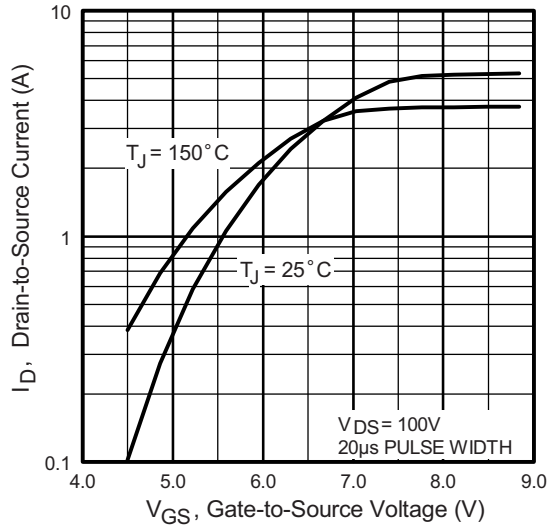


Fig. 2 - Typical Transfer Characteristics

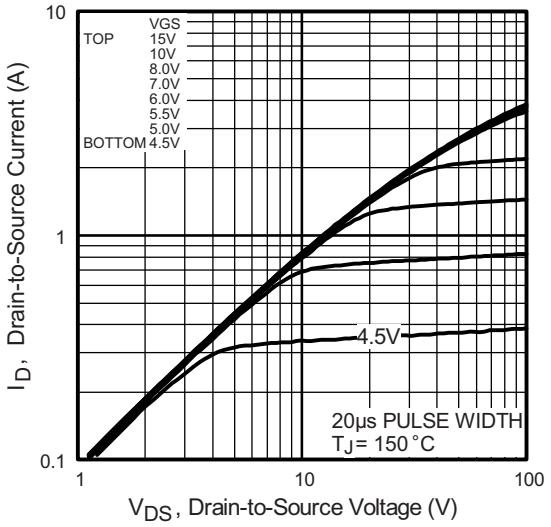


Fig. 1 - Typical Output Characteristics

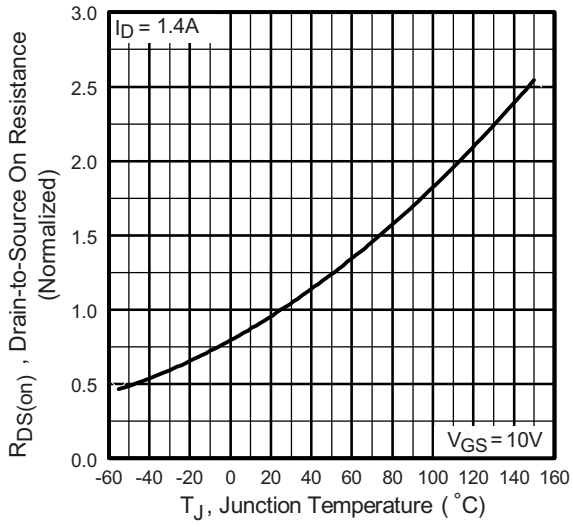


Fig. 3 - Normalized On-Resistance vs. Temperature

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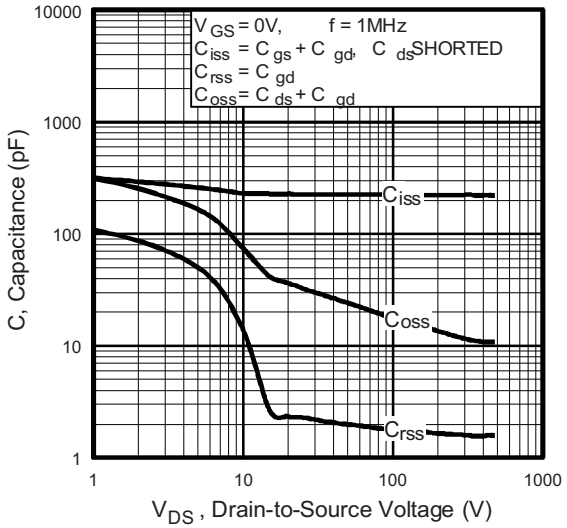


Fig. 4 - Typical Capacitance vs. Drain-to-Source Voltage

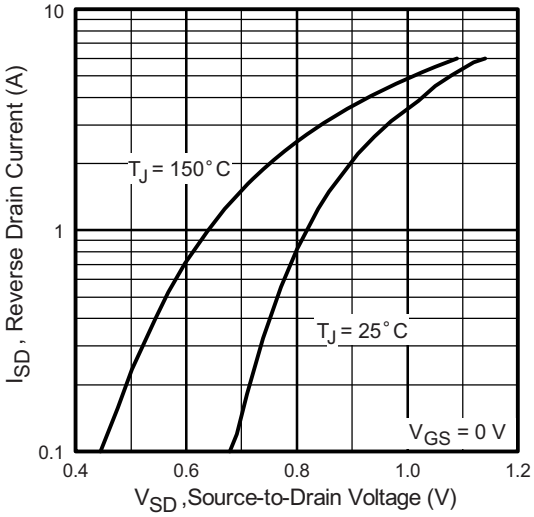


Fig. 6 - Typical Source-Drain Diode Forward Voltage

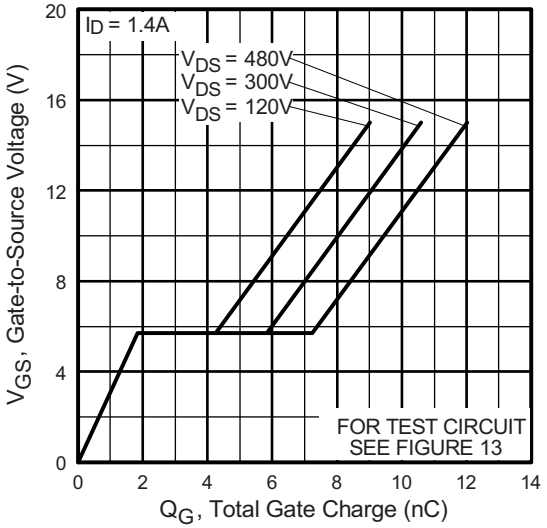


Fig. 5 - Typical Gate Charge vs. Gate-to-Source Voltage

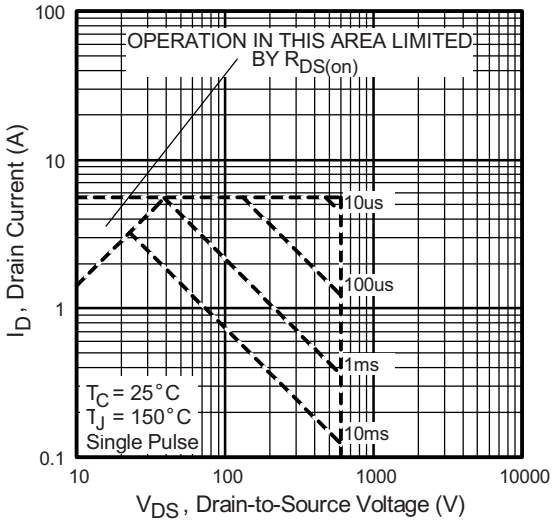


Fig. 7 - Maximum Safe Operating Area

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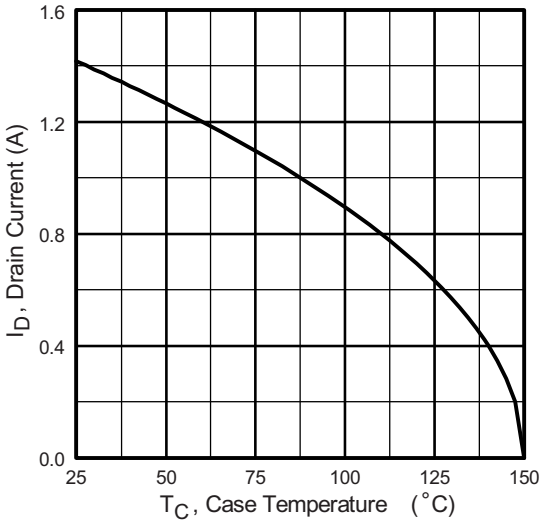


Fig. 8 - Maximum Drain Current vs. Case Temperature

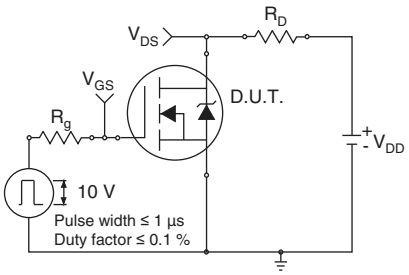


Fig. 10a - Switching Time Test Circuit

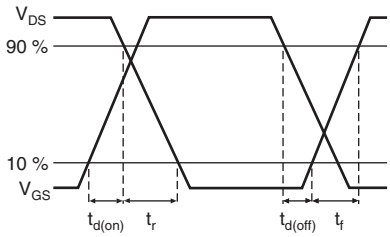


Fig. 10b - Switching Time Waveforms

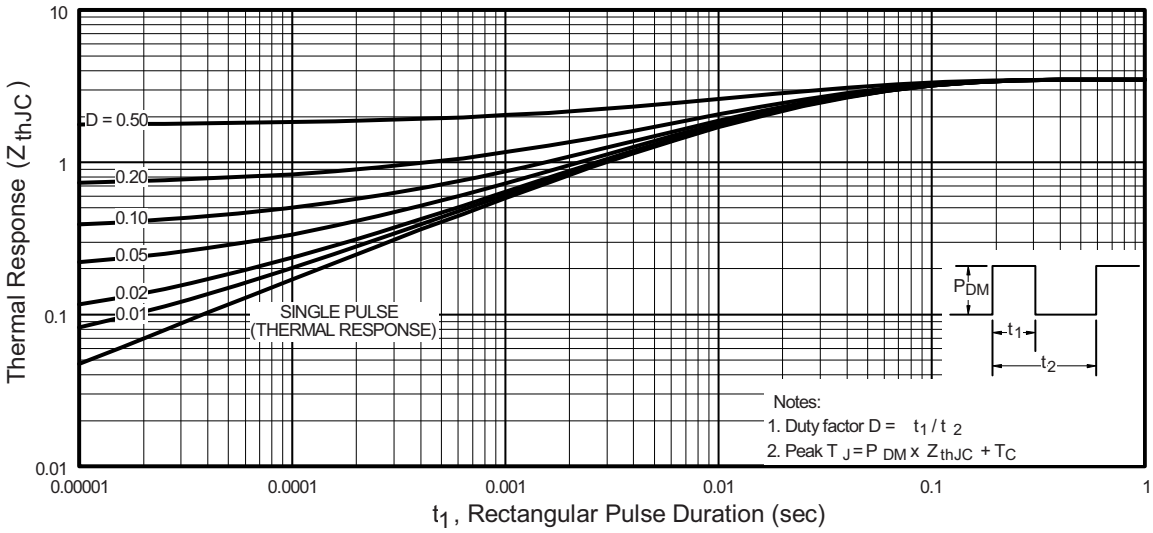


Fig. 9 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

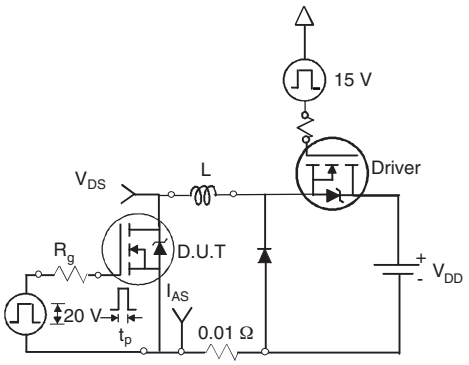


Fig. 12a - Unclamped Inductive Test Circuit

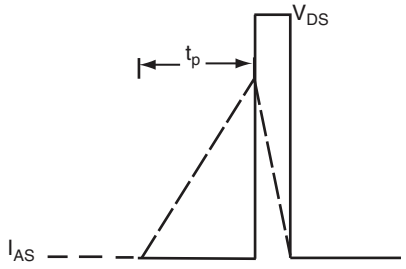


Fig. 12b - Unclamped Inductive Waveforms

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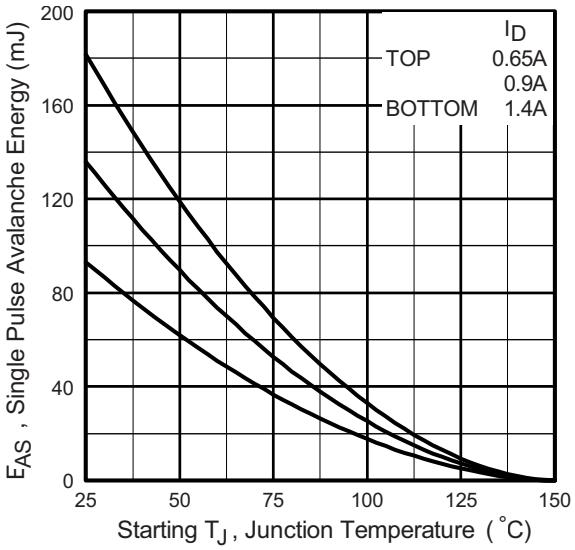


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

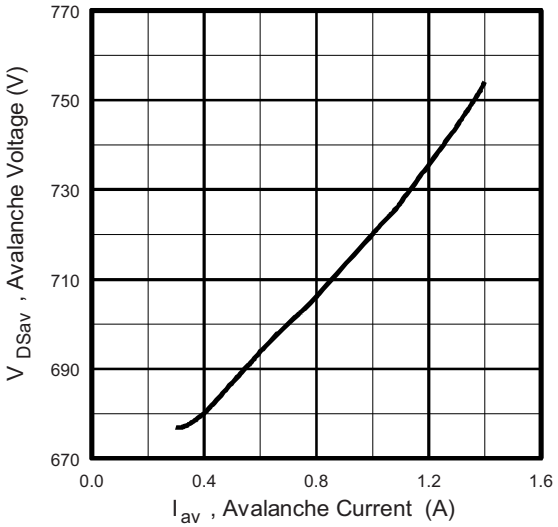


Fig. 12d - Basic Gate Charge Waveform

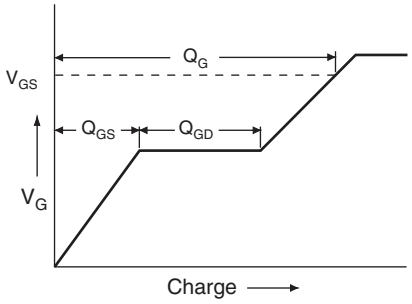


Fig. 13a - Maximum Avalanche Energy vs. Drain Current

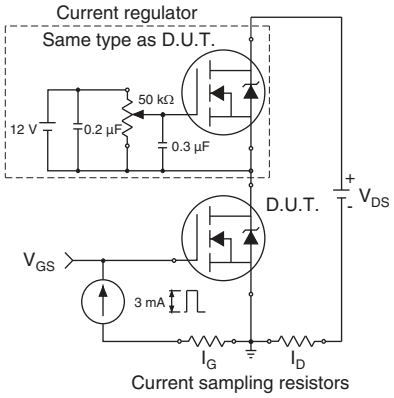
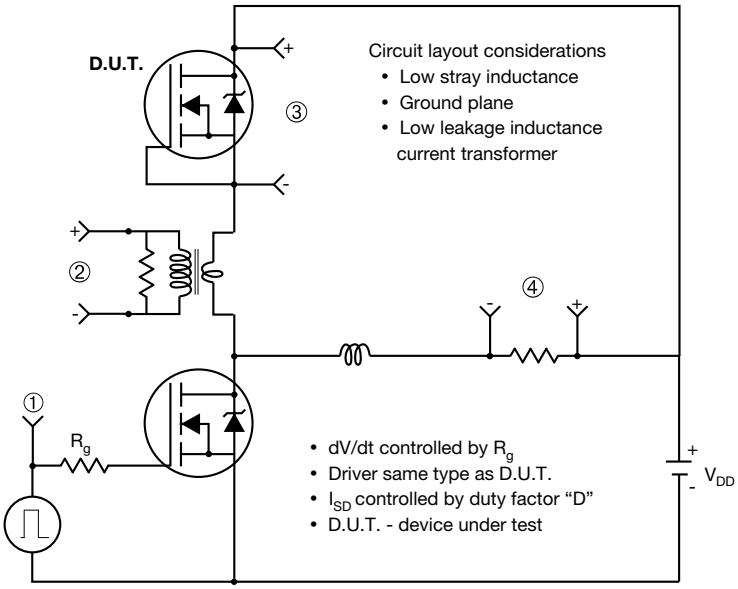
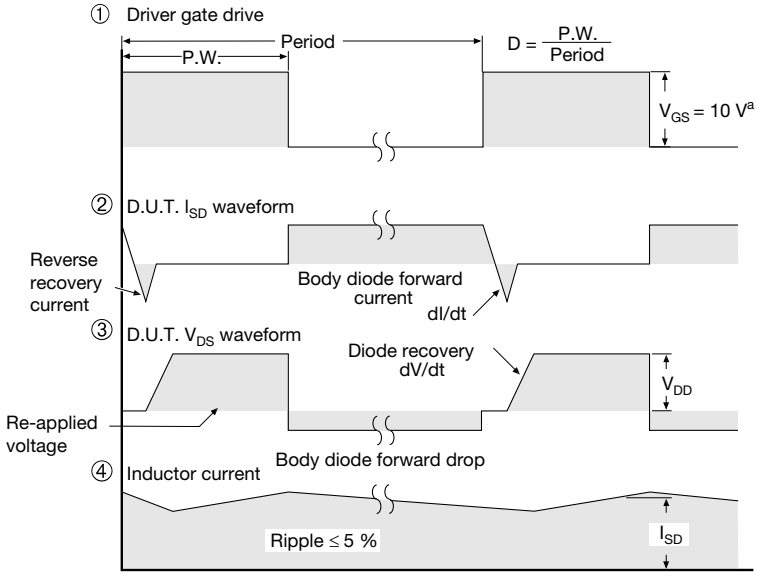


Fig. 13b - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit





Note

a. V_{GS} = 5 V for logic level devices

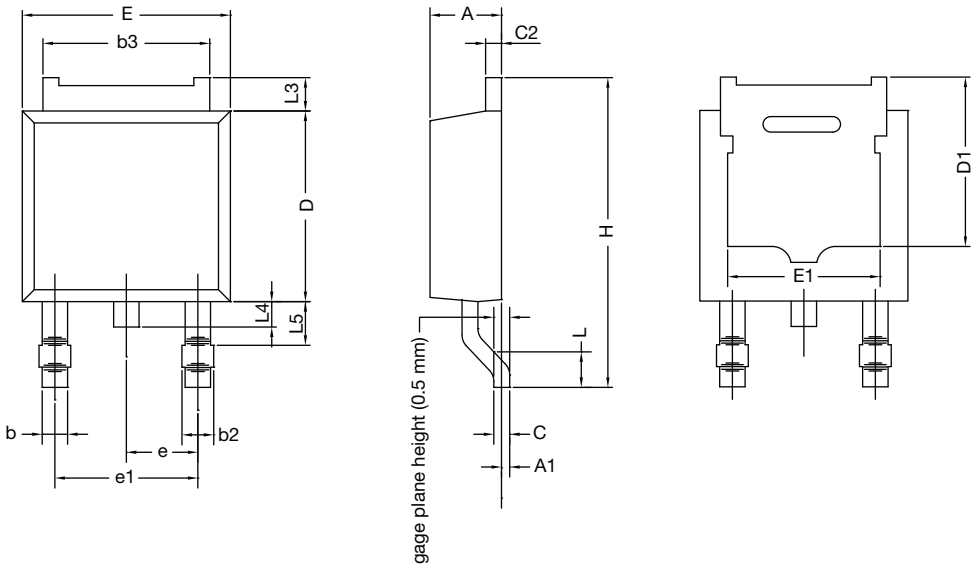
Fig. 10 - For N-Channel

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TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y



	MILLIMETERS	
DIM.	MIN.	MAX.
A	2.18	2.38
A1	-	0.127
b	0.64	0.88
b2	0.76	1.14
b3	4.95	5.46
C	0.46	0.61
C2	0.46	0.89
D	5.97	6.22
D1	4.10	-
E	6.35	6.73
E1	4.32	-
H	9.40	10.41
e	2.28 BSC	
e1	4.56 BSC	
L	1.40	1.78
L3	0.89	1.27
L4	-	1.02
L5	1.01	1.52

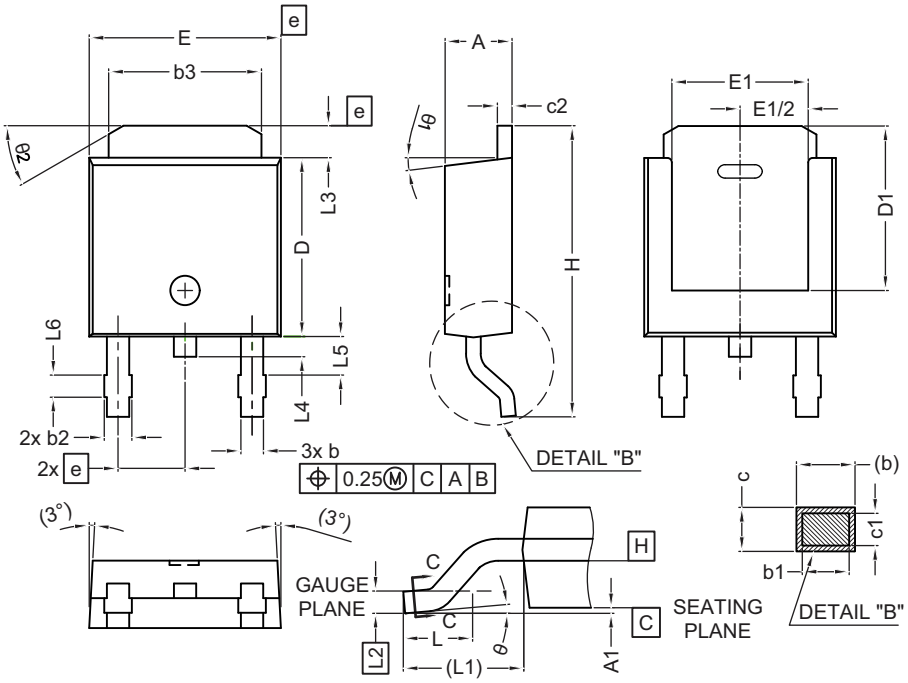
Note

- Dimension L3 is for reference only

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VERSION 2: FACILITY CODE = N



	MILLIMETERS	
DIM.	MIN.	MAX.
A	2.18	2.39
A1	-	0.13
b	0.65	0.89
b1	0.64	0.79
b2	0.76	1.13
b3	4.95	5.46
c	0.46	0.61
c1	0.41	0.56
c2	0.46	0.60
D	5.97	6.22
D1	5.21	-
E	6.35	6.73
E1	4.32	-
e	2.29 BSC	
H	9.94	10.34

	MILLIMETERS	
DIM.	MIN.	MAX.
L	1.50	1.78
L1	2.74 ref.	
L2	0.51 BSC	
L3	0.89	1.27
L4	-	1.02
L5	1.14	1.49
L6	0.65	0.85
θ	0°	10°
θ1	0°	15°
θ2	25°	35°

Notes

- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- Radius on terminal is optional

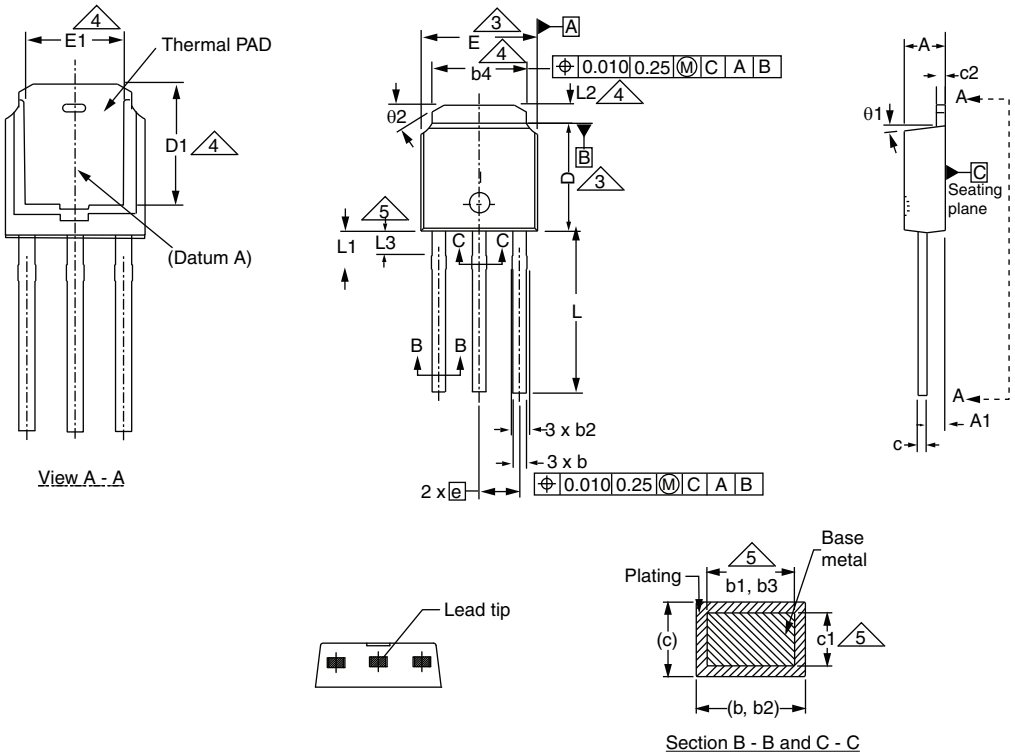
ECN: E22-0399-Rev. R, 03-Oct-2022
DWG: 5347

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Case Outline for TO-251AA (High Voltage)

OPTION 1:



	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
A	2.18	2.39	0.086	0.094
A1	0.89	1.14	0.035	0.045
b	0.64	0.89	0.025	0.035
b1	0.65	0.79	0.026	0.031
b2	0.76	1.14	0.030	0.045
b3	0.76	1.04	0.030	0.041
b4	4.95	5.46	0.195	0.215
c	0.46	0.61	0.018	0.024
c1	0.41	0.56	0.016	0.022
c2	0.46	0.86	0.018	0.034
D	5.97	6.22	0.235	0.245

	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
D1	5.21	-	0.205	-
E	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
e	2.29 BSC		2.29 BSC	
L	8.89	9.65	0.350	0.380
L1	1.91	2.29	0.075	0.090
L2	0.89	1.27	0.035	0.050
L3	1.14	1.52	0.045	0.060
θ1	0'	15'	0'	15'
θ2	25'	35'	25'	35'

ECN: E21-0682-Rev. C, 27-Dec-2021
DWG: 5968

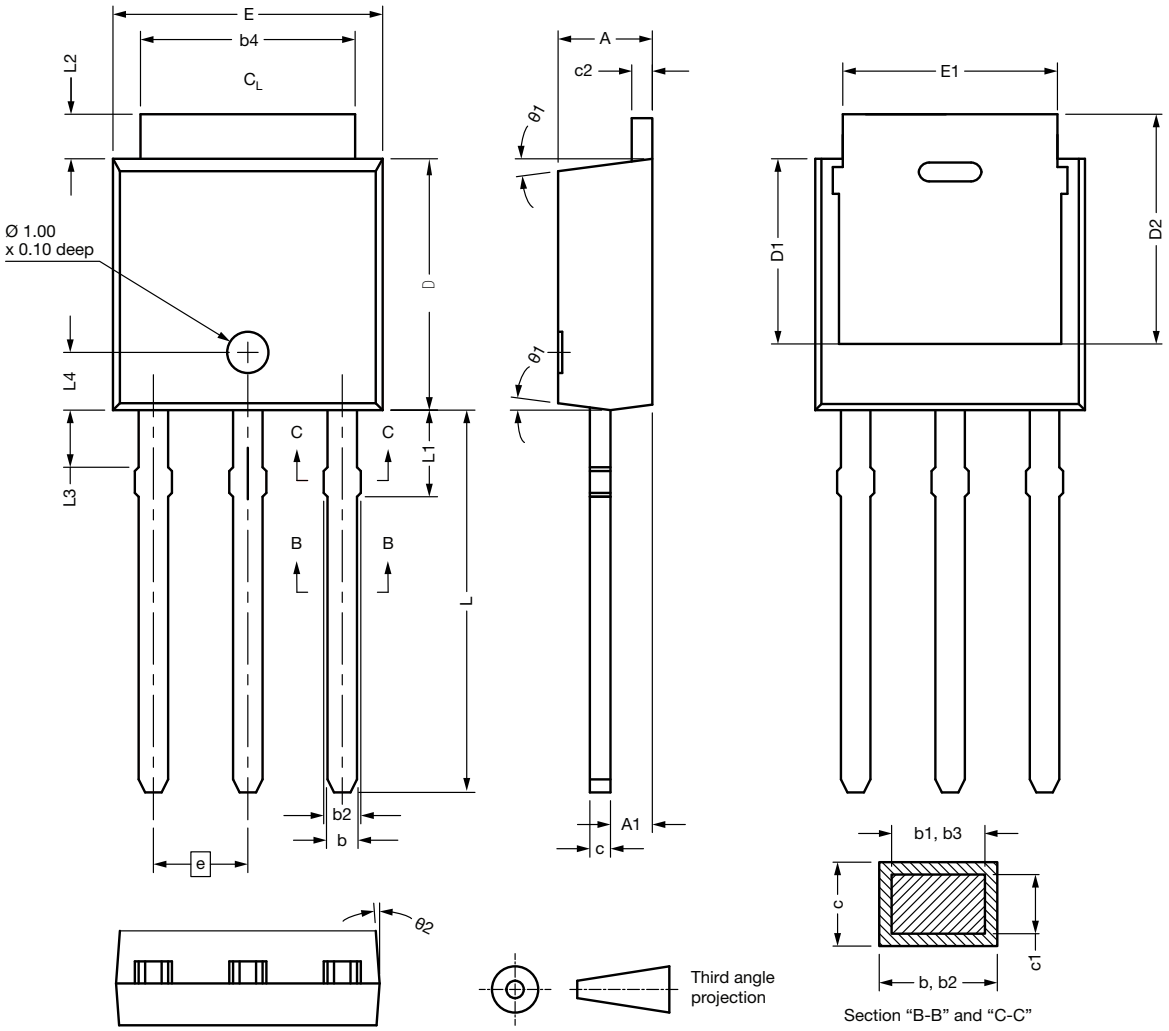
Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994
- Dimension are shown in inches and millimeters
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- Thermal pad contour optional with dimensions b4, L2, E1 and D1
- Lead dimension uncontrolled in L3
- Dimension b1, b3 and c1 apply to base metal only
- Outline conforms to JEDEC® outline TO-251AA

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OPTION 2: FACILITY CODE = N



DIM.	MIN.	NOM.	MAX.
A	2.180	2.285	2.390
A1	0.890	1.015	1.140
b	0.640	0.765	0.890
b1	0.640	0.715	0.790
b2	0.760	0.950	1.140
b3	0.760	0.900	1.040
b4	4.950	5.205	5.460
c	0.460	-	0.610
c1	0.410	-	0.560
c2	0.460	-	0.610
D	5.970	6.095	6.220
D1	4.300	-	-

DIM.	MIN.	NOM.	MAX.
D2	5.380	-	-
E	6.350	6.540	6.730
E1	4.32	-	-
e	2.29 BSC		
L	8.890	9.270	9.650
L1	1.910	2.100	2.290
L2	0.890	1.080	1.270
L3	1.140	1.330	1.520
L4	1.300	1.400	1.500
θ1	0°	7.5°	15°
θ2	4°	-	-

ECN: E21-0682-Rev. C, 27-Dec-2021
DWG: 5968

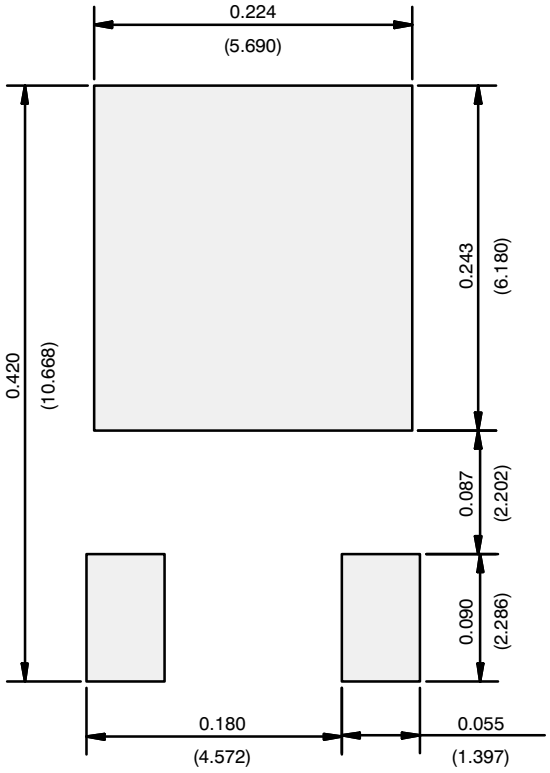
Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994
- All dimension are in millimeters, angles are in degrees
- Heat sink side flash is max. 0.8 mm

For technical questions, contact: hvmos.techsupport@vishay.com

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads
Dimensions in Inches/(mm)

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APPLICATION NOTE

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